

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10589681			
<b>Filing Date:</b>	16-Aug-2006			
<b>Title of Invention:</b>	Polymer Compound, Photoresist Composition Including the Polymer Compound, and Resist Pattern Formation Method			
<b>First Named Inventor/Applicant Name:</b>	Toshiyuki Ogata			
<b>Filer:</b>	Neil S. Bartfeld			
<b>Attorney Docket Number:</b>	SHIGA7.054APC			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	1615	2	50	100
Independent claims in excess of 3	1614	4	210	840
Multiple dependent claims	1616	1	370	370
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1310